## NSN 5962-01-413-4299



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-01-413-4299 **Body Length:** Between 1.140 inches and 1.180 inches **Body Width:** Between 1.140 inches and 1.180 inches **Body Height:** Between 0.070 inches and 0.145 inches **Maximum Power Dissipation Rating:** 2.000 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -55.0/+150.0 degrees celsius **Inclosure Material:** Ceramic **Inclosure Configuration:** Pin grid array **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Current Rating Per Characteristic:** 50.00 milliamperes peak forward surge current horsepower metric **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** 0.5 volts power source and 7.0 volts power source **Time Rating Per Chacteristic:** 90.00 nanoseconds access **Memory Device Type:** Ram **Hybrid Technology Type:** Monolithic **Special Features:** Dynamic operating current 280ma **Terminal Type And Quantity:** 68 printed circuit Shelf Life: N/a **Unit Of Measure:** 

**Demilitarization:** No

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